

Manual

HIMax®

X-AI 32 02

Analog Input Module with Sequence of Events Recording



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X-AI 32 02 1 Introduction

1 Introduction

This manual describes the technical characteristics of the module and its use. It provides information on how to install, start up and configure the module in SILworX.

1.1 Structure and Use of This Manual

The content of this manual is part of the hardware description of the HIMax programmable electronic system.

This manual contains the following main chapters:

- Introduction
- Safety
- Product description
- Start-up
- Operation
- Maintenance
- Decommissioning
- Transport
- Disposal

Additionally, the following documents must be taken into account:

Document	Content	Document no.
HIMax system manual	Hardware description of the HIMax system	HI 801 001 E
HIMax safety manual	Safety functions of the HIMax system	HI 801 003 E
HIMax maintenance manual	Description of significant operational and maintenance actions.	HI 801 171 E
Communication manual	Description of safeethernet communication and of the available protocols.	HI 801 101 E
Automation security manual	Description of automation security aspects in conjunction with HIMA systems.	HI 801 373 E
SILworX first steps manual	Introduction to SILworX	HI 801 103 E
SILworX online help (OLH)	Instructions on how to use SILworX	

Table 1: Additional Applicable Manuals

The current manuals can be obtained upon request by sending an e-mail to: documentation@hima.com. For registered HIMA customers, the product documentation is available at https://www.hima.com/en/downloads/.

1.2 Target Audience

This document is aimed at the planners, design engineers and programmers of automation systems as well as the persons authorized to start up, operate and maintain the devices and systems concerned. Specialized knowledge of safety-related automation systems is required.

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1 Introduction X-AI 32 02

1.3 Writing Conventions

To ensure improved readability and comprehensibility, the following writing conventions are used in this document:

Bold To highlight important parts.

Names of buttons, menu functions and tabs that can be clicked and used

in the programming tool.

Italics Parameters and system variables, references.

Courier Literal user inputs.

RUN Operating states are designated by capitals.

Chapter 1.2.3 Cross-references are hyperlinks even if they are not specially marked.

In the electronic document (PDF): When the mouse pointer hovers over a hyperlink, it changes its shape. Click the hyperlink to jump to the

corresponding position.

Safety notices and operating tips are specially marked.

1.3.1 Safety Notices

Safety notices must be strictly observed to ensure the lowest possible risk.

The safety notices are represented as described below.

- Signal word: warning, caution, notice.
- Type and source of risk.
- Consequences arising from non-observance.
- Risk prevention.

The signal words have the following meanings:

- Warning indicates hazardous situations which, if not avoided, could result in death or serious injury.
- Caution indicates hazardous situation which, if not avoided, could result in minor or moderate injury.
- Notice indicates a hazardous situation which, if not avoided, could result in property damage.

SIGNAL WORD



Type and source of risk!

Consequences arising from non-observance.

Risk prevention.

NOTICE



Type and source of damage! Damage prevention.

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1.3.2 Operating Tips Additional information is structured as presented in the following example: The text giving additional information is located here. Useful tips and tricks appear as follows:

TIP

The tip text is located here.

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1 Introduction X-AI 32 02

1.4 Safety Lifecycle Services

HIMA provides support throughout all the phases of the plant's safety lifecycle, from planning and engineering through commissioning to maintenance of safety and security.

HIMA's technical support experts are available for providing information and answering questions about our products, functional safety and automation security.

To achieve the qualification required by the safety standards, HIMA offers product or customerspecific seminars at HIMA's training center or on site at the customer's premises. The current seminar program for functional safety, automation security and HIMA products can be found on HIMA's website.

Safety Lifecycle Services:

Onsite+ / On-Site **Engineering**

In close cooperation with the customer, HIMA performs changes or

extensions on site.

Startup+ / Preventive Maintenance

HIMA is responsible for planning and executing preventive maintenance measures. Maintenance actions are carried out in accordance with the manufacturer's specifications and are

documented for the customer.

Lifecycle+ / Lifecycle

Management

As part of its lifecycle management processes, HIMA analyzes the current status of all installed systems and develops specific

recommendations for maintenance, upgrading and migration.

Hotline+ / 24 h

Hotline

HIMA's safety engineers are available by telephone around the clock

to help solve problems.

Standby+ / 24 h Call-

Out Service

Faults that cannot be resolved over the phone are processed by HIMA's specialists within the time frame specified in the contract.

Logistics+/24 h Spare Parts Service HIMA maintains an inventory of necessary spare parts and

guarantees quick, long-term availability.

Contact details:

Safety Lifecycle Services

https://www.hima.com/en/about-hima/contacts-worldwide/

Technical Support

https://www.hima.com/en/products-services/support/

Seminar Program https://www.hima.com/en/products-services/seminars//

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2 Safety

All safety information, notes and instructions specified in this document must be strictly observed. The product may only be used if all guidelines and safety instructions are adhered to.

The product is operated with SELV or PELV. No imminent risk results from the product itself. Use in the Ex zone is only permitted if additional measures are taken.

2.1 Intended Use

HIMax components are designed for assembling safety-related controller systems.

When using the components in the HIMax system, comply with the following general requirements.

2.1.1 Environmental Requirements

All the environmental requirements specified in this manual must be observed when operating the HIMax system. The environmental requirements are listed in the product data.

2.1.2 ESD Protective Measures

Only personnel with knowledge of ESD protective measures may modify or extend the system or replace components.

NOTICE



Damage to the HIMax system due to electrostatic discharge!

- When performing the work, make sure that the workspace is free of static, and wear a grounding strap.
- If not used, ensure that the components are protected from electrostatic discharge, e.g., by storing them in their packaging.

2.2 Residual Risk

No imminent risk results from a HIMA system itself.

Residual risk may result from:

- Faults related to engineering.
- Faults in the user program.
- Faults related to the wiring.

2.3 Safety Precautions

Observe all local safety requirements and use the protective equipment required on site.

2.4 Emergency Information

A HIMA system is a part of the safety equipment of an overall system. If the controller fails, the system enters the safe state.

In case of emergency, no action that may prevent the HIMA system from operating safely is permitted.

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3 Product Description X-AI 32 02

3 Product Description

The X-AI 32 02 is an analog input module is intended for use in the programmable electronic system (PES) HIMax.

The module is used to evaluate up to 32 analog input signals.

The module is suitable for sequence of events recording (SOE). Events are recorded within a module cycle of 2 ms, refer to Chapter 4.3 for details,

The module can be inserted into any of the base plate slots with the exception of the slots reserved for system bus modules. Refer to the system manual (HI 801 001 E) for details.

The module is interference-free. In particular with respect to EMC, electrical safety, communication to the X-SB and X-CPU modules, and the user program.

The module has been certified by the TÜV for safety-related applications up to SIL 3 (IEC 61508, IEC 61511, IEC 62061 and EN 50156) as well as Cat. 4 and PL e (EN ISO 13849-1).

3.1 Safety Function

The module measures the current of the connected devices with the specified accuracy, providing the transmitter supply with a guaranteed minimum voltage.

The safety function is performed in accordance with SIL 3.

3.1.1 Response in the Event of a Fault

If a fault occurs, the module adopts the safe state and the assigned input variables transmit the initial value (default value = 0) to the user program.

The initial values must be set to 0 to ensure that the input variables transmit the value 0 to the user program if a fault occurs. If the raw value is evaluated instead of the process value, the user must program the monitoring function and the value in the event of faults from within the user program.

The module activates the *Error* LED on the front plate.

3.2 Scope of Delivery

To operate, the module must be installed on a matching connector board. If a field termination assembly (FTA) is used, a system cable is required to connect the connector board to the FTA. Connector boards, system cables and FTAs are not included within the scope of delivery.

The connector boards are described in Chapter 3.7, the system cables are described in Chapter 3.8. The FTAs are described in separate manuals.

3.3 X-AI 32 02 Certification

Refer to the HIMax safety manual (HI 801 003 E) for more information on the standards used to test and certify the module and the HIMax system.

The certificates and the EU type test certificate are available on the HIMA website.

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3.4 Type Label

The type label specifies the following important details:

- Product name
- Mark of conformity
- Bar code (2D or 1D code)
- Part number (Part-No.)
- Hardware revision index (HW-Rev.)
- Operating system revision index (OS-Rev.)
- Supply voltage (Power)
- Ex specifications (if applicable)
- Production year (Prod-Year:)



Figure 1: Sample Type Label

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3.5 Structure

The module has 32 analog current inputs (0/4...20 mA), each input is measured and functionally tested using two internal measuring devices. A short-circuit-proof transmitter supply is assigned to each input.

The 32 analog inputs can be used to evaluate the values measured for the transmitters and safety transmitters. 2-wire or 3-wire transmitters with a maximum supply current of 30 mA can be connected to the module.

The functional units are galvanically separated for interference-free measurement of the analog input signals.

The 1oo2 processor system within the I/O module controls and monitors the I/O level. The data and states of the I/O module are provided to the processor modules via the redundant system bus. The system bus has a redundant structure for reasons of availability. Redundancy is only ensured if both system bus modules are inserted in the base plates and configured in SILworX.

The module is equipped with LEDs to indicate the status of the digital inputs, see Chapter 3.5.2.

3.5.1 Block Diagram

The following block diagram illustrates the structure of the module:

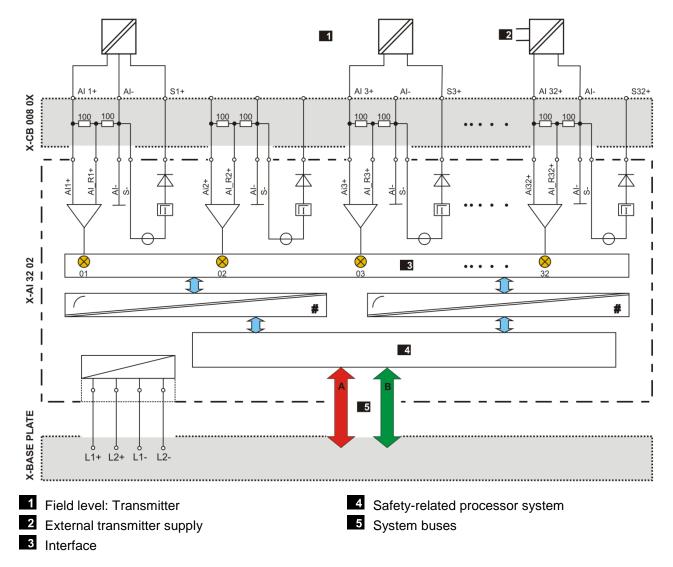


Figure 2: Block Diagram

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3.5.2 Indicators

The following figure shows the front view of the module with the LEDs.

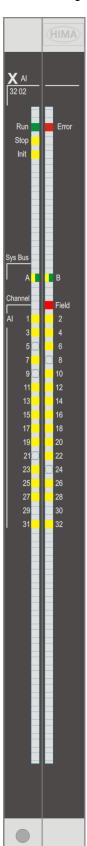


Figure 3: Front View

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The LEDs indicate the operating state of the module.

The LEDs on the module are divided into three groups:

- Module status indicators (Run, Error, Stop, Init)
- System bus indicators (A, B)
- I/O indicators (AI 1...32, Field)

After connecting the supply voltage, an LED test is performed and all the LEDs are lit for at least 2 s. The color of two-color LEDs changes once during the test.

X-AI 32 02

Definition of blinking frequencies

The following table defines the blinking frequencies:

Definition	Blinking frequencies
Blinking1	Long (600 ms) on, long (600 ms) off.
Blinking2	Short (200 ms) on, short (200 ms) off, short (200 ms) on, long (600 ms) off.
Blinking-x	Ethernet communication: Blinking synchronously with data transmission.

Table 2: Blinking Frequencies of the LEDs

Some LEDs can report warnings (On) and faults or errors (Blinking1), see the following tables. The indication of errors or faults has priority over the indication of warnings. Warnings cannot be reported if errors or faults are being signaled.

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3.5.3 Module Status Indicators

These LEDs are located on the upper part of the front plate.

LED	Color	Status	Description
Run	Green	On	Module in the RUN state, normal operation.
		Blinking1	Module state STOP / LOADING OS
		Off	Module not in the RUN state, observe the other status LEDs.
Error	Red	On	System warning, for example: No license for additional functions (e.g., communication protocols), test mode. Temperature warning
		Blinking1	System error, for example: Internal module faults detected by self-tests, e.g., hardware or voltage supply faults. Fault while loading the operating system.
		Off	No faults detected
Stop	Yellow	On	Module state STOP / VALID CONFIGURATION
		Blinking1	The module is in one of the following states: STOP / INVALID CONFIGURATION STOP / LOADING OS
		Off	Module not in the STOP state, observe the other status LEDs.
Init	Yellow	On	Module state: INIT
		Blinking1	The module is in one of the following states: LOCKED STOP / LOADING OS
		Off	Module is in none of the states described, observe the other status LEDs.

Table 3: Module Status Indicators

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3.5.4 System Bus Indicators

The system bus indicator LEDs are labeled Sys Bus.

LED	Color	Status	Description
А	Green	On	Physical and logical connection to the system bus module in slot 1.
		Blinking1	No physical connection to the system bus module in slot 1.
	Yellow	Blinking1	The physical connection to the system bus module in slot 1 has been established.
			No connection to a (redundant) processor module running in system operation.
В	Green	On	Physical and logical connection to the system bus module in slot 2.
		Blinking1	No physical connection to the system bus module in slot 2.
	Yellow	Blinking1	The physical connection to the system bus module in slot 2 has been established.
			No connection to a (redundant) processor module running in system operation.
A+B	Off	Off	Neither physical nor logical connection to the system bus modules in slot 1 and slot 2.

Table 4: System Bus Indicators

3.5.5 I/O Indicators

The LEDs of the I/O indicators are labeled Channel.

LED	Color	Status	Description
AI 132	Yellow	On	The input current is > 4 mA or greater than the HIGH switching point (dig) configured in SILworX.
		Blinking2	Channel fault (module field or hardware fault). Input current > 20 mA
		Off	The input current is < 4 mA or less than the LOW switching point (dig) configured in SILworX.
Field	Red	Blinking2	Field fault on at least one channel or supply (open-circuit, short-circuit, over-current, etc.) Depending on the configured current thresholds.
		Off	No faults at the field level

Table 5: I/O Indicators

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3.6 Product Data

General	
Supply voltage	24 VDC, -15+20 %, r _p ≤ 5 %
	SELV, PELV
Current consumption	500 mA at 24 VDC (without channels or transmitter supplies)
	Max. 1.5 A (if the max. output current is applied to the
	transmitter supplies)
Module cycle time	2 ms
Protection class	Protection class III in accordance with IEC/EN 61131-2.
Operating temperature	0+60 °C
Storage temperature	-40+85 °C
Humidity	Max. 95 % relative humidity, non-condensing
Pollution	Pollution degree II in accordance with IEC/EN 60664-1
Altitude	< 2000 m
Degree of protection	IP20
Dimensions (H x W x D) in mm	310 x 29.2 x 230
Weight	Approx. 1.4 kg

Table 6: Product Data

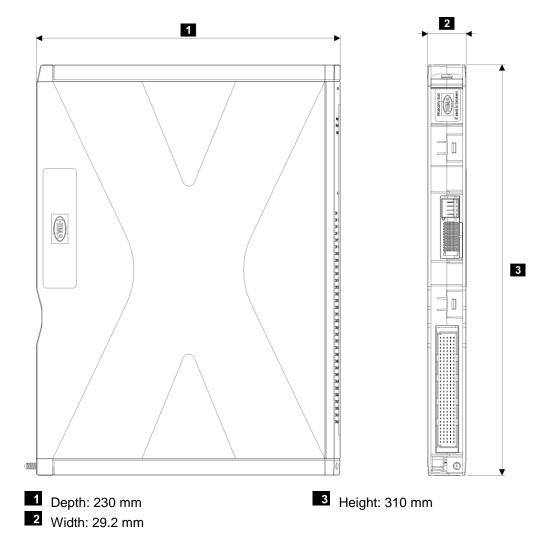


Figure 4: Views

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Analog inputs	
Number of inputs (number of channels)	32 with common ground AI- (galvanic separation from the system bus and the 24 VDC supply voltage).
Nominal range	0/420 mA
Operating range	022.5 mA
Digital resolution	12-bit
Shunt for current measurement	200 Ω
Maximum permitted current via shunt	50 mA
Withstand voltage of the input	≤ 10 VDC
Interference voltage suppression	> 60 dB (common mode 50/60 Hz)
Sequence of events recording cycle	2 ms
Metrological accuracy	
Metrological accuracy at 25 °C	Type: ±0.1 % of full scale
	Max. ±0.2 % of full scale
Metrological accuracy across the entire	Type: ±0.15 % of full scale
temperature range.	Max. ±0.3 % of full scale
Settling time to 99 % of the process value when the input signal changes.	15 ms

Table 7: Specifications for the Analog Inputs

Transmitter supply	
Number of transmitter supplies	32
Output voltage for transmitter supply	26.5 VDC +0/-15 %
Output current of transmitter supply	Max. 30 mA
Transmitter supply monitoring	Undervoltage: 21.5 VDC
	Overvoltage: 30 VDC
Max. number of transmitter supplies that may be simultaneously short-circuited.	If more than 12 supplies are short-circuited for longer than 3 s, the entire transmitter supply is switched off. If the overload disappears, the transmitter supply is switched on again within 30 s.
Maximum connectable load (transmitter + wire)	≤ 750 Ω at 22.5 mA

Table 8: Specifications for the Transmitter Supply

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3.7 Connector Boards

A connector board connects the module to the field level. Module and connector board together form a functional unit. Insert the connector board into the appropriate slot prior to mounting the module. The following connector boards are available for the module:

Connector board	Description
X-CB 008 01	Connector board with screw terminals
X-CB 008 02	Redundant connector board with screw terminals
X-CB 008 03	Connector board with cable plug
X-CB 008 04	Redundant connector board with cable plug
X-CB 008 05	Redundant connector board with cable plug, redundant field termination assembly

Table 9: Available Connector Boards

3.7.1 Mechanical Coding of Connector Boards

I/O modules and connector boards are mechanically coded starting from hardware revision index (HW-Rev.) 10. Coding avoids installation of improper I/O modules thus preventing negative effects on redundant modules and the field level.

Apart from that, improper equipment has no effect on the HIMax system since only I/O modules properly configured in SILworX can enter the RUN state.

I/O modules and the corresponding connector boards have a mechanical coding in the form of wedges. The coding wedges in the female connector of the connector board match with the male connector recesses of the I/O module plug, see Figure 5.

Coded I/O modules can only be plugged in to the corresponding connector boards.

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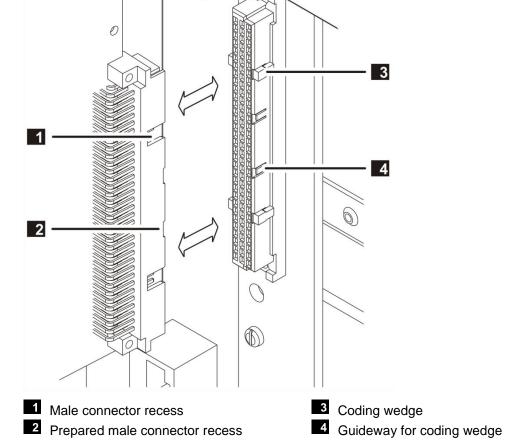


Figure 5: Coding Example

Coded I/O modules can be plugged in to uncoded connector boards. Uncoded I/O modules cannot be plugged in to coded connector boards.

3.7.2 Coding of X-CB 008 0X Connector Boards

The following table specifies the position of the coding wedges on the I/O module plug:

a7	a13	a20	a26	e7	e13	e20	e26
		X		X		X	

Table 10: Position of Coding Wedges

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3.7.3 Pin Assignment for Connector Boards with Screw Terminals

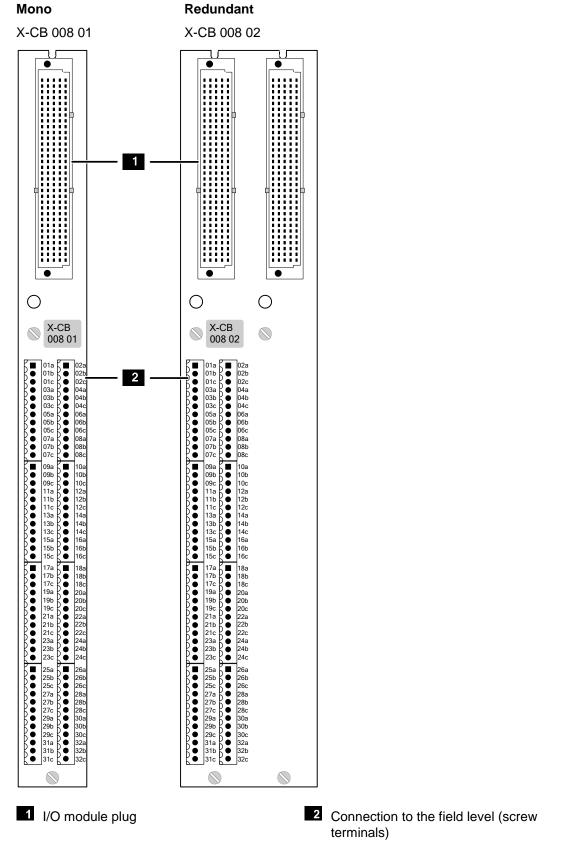


Figure 6: Connector Boards with Screw Terminals

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3.7.4 Terminal Assignment for Connector Boards with Screw Terminals

Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	01a	S1+	1	02a	S2+
2	01b	Al1+	2	02b	Al2+
3	01c	Al1-	3	02c	Al2-
4	03a	S3+	4	04a	S4+
5	03b	Al3+	5	04b	Al4+
6	03c	Al3-	6	04c	Al4-
7	05a	S5+	7	06a	S6+
8	05b	Al5+	8	06b	Al6+
9	05c	Al5-	9	06c	Al6-
10	07a	S7+	10	08a	S8+
11	07b	AI7+	11	08b	Al8+
12	07c	AI7-	12	08c	Al8-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	09a	S9+	1	10a	S10+
2	09b	AI9+	2	10b	AI10+
3	09c	AI9-	3	10c	AI10-
4	11a	S11+	4	12a	S12+
5	11b	Al11+	5	12b	Al12+
6	11c	Al11-	6	12c	Al12-
7	13a	S13+	7	14a	S14+
8	13b	Al13+	8	14b	AI14+
9	13c	AI13-	9	14c	AI14-
10	15a	S15+	10	16a	S16+
11	15b	AI15+	11	16b	AI16+
12	15c	AI15-	12	16c	AI16-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	17a	S17+	1	18a	S18+
2	17b	AI17+	2	18b	AI18+
3	17c	AI17-	3	18c	AI18-
4	19a	S19+	4	20a	S20+
5	19b	AI19+	5	20b	Al20+
6	19c	AI19-	6	20c	Al20-
7	21a	S21+	7	22a	S22+
8	21b	Al21+	8	22b	Al22+
9	21c	Al21-	9	22c	Al22-
10	23a	S23+	10	24a	S24+
11	23b	Al23+	11	24b	Al24+
12	23c	Al23-	12	24c	Al24-

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Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	25a	S25+	1	26a	S26+
2	25b	Al25+	2	26b	Al26+
3	25c	Al25-	3	26c	Al26-
4	27a	S27+	4	28a	S28+
5	27b	Al27+	5	28b	Al28+
6	27c	Al27-	6	28c	Al28-
7	29a	S29+	7	30a	S30+
8	29b	Al29+	8	30b	Al30+
9	29c	Al29-	9	30c	Al30-
10	31a	S31+	10	32a	S32+
11	31b	Al31+	11	32b	Al32+
12	31c	Al31-	12	32c	Al32-

Table 11: Terminal Assignment for Connector Boards with Screw Terminals

Cable plugs attached to the connector board pin headers are used to connect to the field level.

The cable plugs feature the following characteristics:

Connection to the field level				
Cable plugs	8 pieces, with 12 poles			
Wire cross-section	0.21.5 mm ² (single-wire)			
	0.21.5 mm ² (finely stranded)			
	0.21.5 mm ² (with wire end ferrule)			
Stripping length	6 mm			
Screwdriver	Slotted 0.4 x 2.5 mm			
Tightening torque	0.20.25 Nm			

Table 12: Cable Plug Characteristics

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3 Product Description X-Al 32 02

3.7.5 Pin Assignment for Connector Boards with Cable Plug

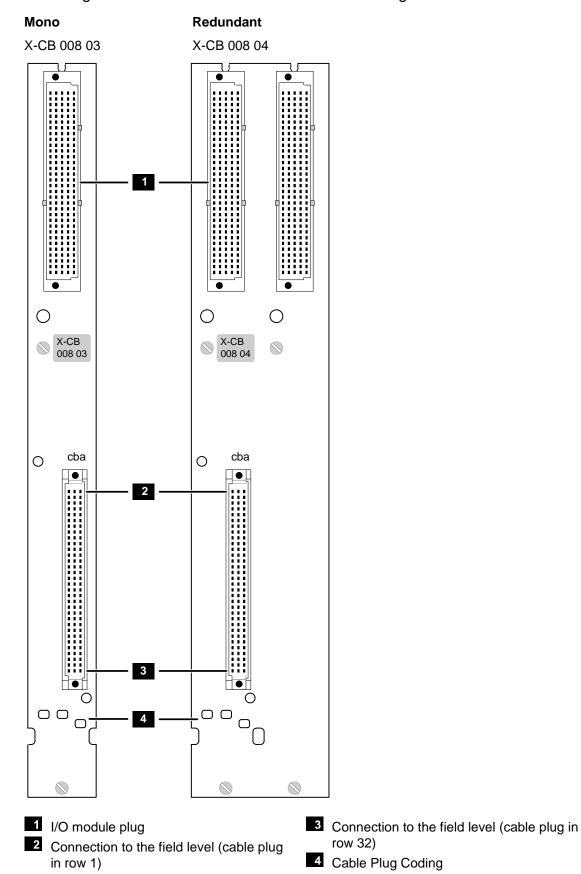


Figure 7: Connector Boards with Cable Plug

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3.7.6 Pin Assignment for Connector Boards with Cable Plug

HIMA provides ready-made system cables for use with these connector boards, see Chapter 3.8. The cable plug and the connector boards are coded.

Connector pin assignment!

The following table describes the connector pin assignment of the system cable plug.

The wire color coding complies with IEC 60304. The color abbreviations used are in accordance with IEC 60757.

The following table applies to system cables X-CA 005:

Row		С	b		a	а	
ROW	Signal	Color	Signal	Color	Signal	Color	
1	S32+	PKBN 1)	Al32+	WHPK 1)		YEBU 1)	
2	S31+	GYBN 1)	Al31+	WHGY 1)	Internal use	GNBU 1)	
3	S30+	YEBN 1)	Al30+	WHYE 1)	3)	YEPK 1)	
4	S29+	BNGN 1)	Al29+	WHGN 1)		PKGN 1)	
5	S28+	RDBU 1)	Al28+	GYPK 1)	AI-		
6	S27+	VT 1)	Al27+	BK 1)	AI-		
7	S26+	RD 1)	Al26+	BU 1)	AI-		
8	S25+	PK 1)	Al25+	GY 1)	AI-		
9	S24+	YE 1)	Al24+	GN 1)	AI-		
10	S23+	BN 1)	Al23+	WH 1)	AI-		
11	S22+	RDBK	Al22+	BUBK	AI-		
12	S21+	PKBK	Al21+	GYBK	AI-		
13	S20+	PKRD	AI20+	GYRD	AI-		
14	S19+	PKBU	Al19+	GYBU	AI-		
15	S18+	YEBK	AI18+	GNBK	AI-		
16	S17+	YERD	AI17+	GNRD	AI-		
17	S16+	YEBU	Al16+	GNBU	AI-		
18	S15+	YEPK	AI15+	PKGN	AI-		
19	S14+	YEGY	Al14+	GYGN	AI-		
20	S13+	BNBK	Al13+	WHBK	AI-		
21	S12+	BNRD	Al12+	WHRD	AI-		
22	S11+	BNBU	Al11+	WHBU	AI-		
23	S10+	PKBN	AI10+	WHPK	AI-		
24	S9+	GYBN	Al9+	WHGY	AI-		
25	S8+	YEBN	Al8+	WHYE	AI-	YEGY 1)	
26	S7+	BNGN	AI7+	WHGN	AI-	GYGN 1)	
27	S6+	RDBU	Al6+	GYPK	AI-	BNBK 1)	
28	S5+	VT	Al5+	BK	AI-	WHBK 1)	
29	S4+	RD	Al4+	BU	AI-	BNRD 1)	
30	S3+	PK	Al3+	GY	AI-	WHRD 1)	
31	S2+	YE	Al2+	GN	AI-	BNBU 1)	
32	S1+	BN	Al1+	WH	AI-	WHBU 1)	

¹⁾ For repeated wire color coding: Additional orange ring.

Table 13: Pin Assignment for the Cable Plugs of System Cable X-CA 005

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²⁾ The wires must be isolated individually! No other use is permitted!

The following table applies to system cables X-CA 016:

		С		b		a		
Row	Signal	Color	Signal	Color	Signal	Color		
1			Al32+	WHPK 1)				
2			Al31+	WHGY 1)				
3			Al30+	WHYE 1)				
4			Al29+	WHGN 1)				
5			Al28+	GYPK 1)	AI- (a5)	See also Table 15		
6			Al27+	BK 1)	Al27-	VT 1)		
7			Al26+	BU 1)	Al26-	RD 1)		
8			Al25+	GY 1)	Al25-	PK 1)		
9			Al24+	GN 1)	Al24-	YE 1)		
10			Al23+	WH 1)	Al23-	BN 1)		
11			Al22+	BUBK	Al22-	RDBK		
12			Al21+	GYBK	Al21-	PKBK		
13			Al20+	GYRD	Al20-	PKRD		
14			Al19+	GYBU	AI19-	PKBU		
15			Al18+	GNBK	AI18-	YEBK		
16			AI17+	GNRD	AI17-	YERD		
17			Al16+	GNBU	AI16-	YEBU		
18			Al15+	PKGN	AI15-	YEPK		
19			Al14+	GYGN	AI14-	YEGY		
20			Al13+	WHBK	AI13-	BNBK		
21			Al12+	WHRD	AI12-	BNRD		
22			Al11+	WHBU	AI11-	BNBU		
23			AI10+	WHPK	AI10-	PKBN		
24			Al9+	WHGY	AI9-	GYBN		
25			Al8+	WHYE	Al8-	YEBN		
26			AI7+	WHGN	AI7-	BNGN		
27			Al6+	GYPK	Al6-	RDBU		
28			Al5+	BK	AI5-	VT		
29			Al4+	BU	Al4-	RD		
30			Al3+	GY	AI3-	PK		
31			Al2+	GN	Al2-	YE		
32			Al1+	WH	Al1-	BN		

Table 14: Pin Assignment for the Cable Plugs of System Cable X-CA 016

Signals Al28-...Al32- are combined in the cable plug, see Table 15.

Row	Signal	Color			
a5 (AI-)	Al32-	PKBN 1)			
	Al31-	GYBN 1)			
	Al30-	YEBN 1)			
	Al29-	BNGN 1)			
	Al28-	RDBU 1)			
1) For repeated wire color coding: Additional orange ring.					

Table 15: Al- Used with Five Wires

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3.7.7 Connector Board Redundancy using two Base Plates

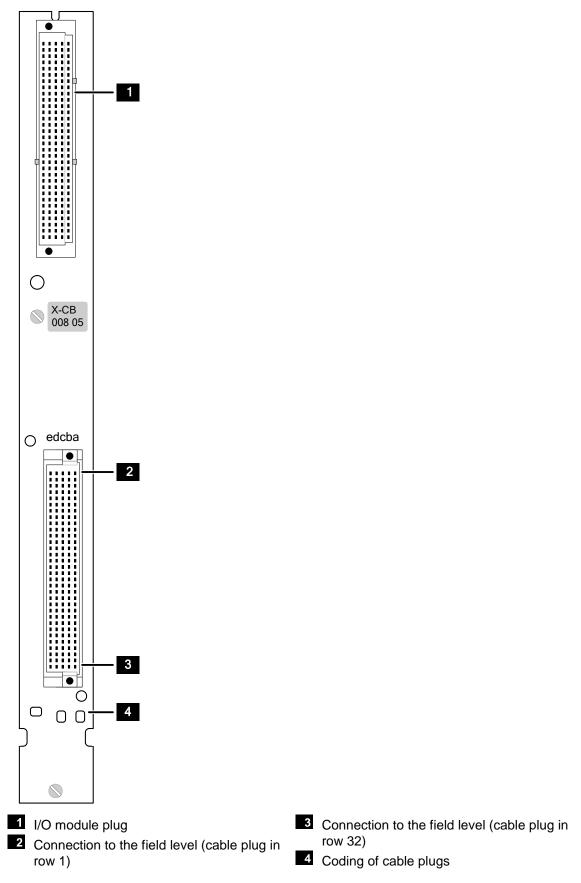


Figure 8: Connector Board with Cable Plug, Variant X-CB 008 05

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3.7.8 Pin Assignment for X-CB 008 05

HIMA provides ready-made system cables for use with this connector board, see Chapter 3.8. The cable plug and the connector boards are coded.

Connector pin assignment!

The following table describes the connector pin assignment of the system cable plug.

The wire color coding complies with IEC 60304. The color abbreviations used are in accordance with IEC 60757.

The following table applies to system cables X-CA 009:

D	е		d		С		b		а	
Row	Signal	Color	Signal	Color	Signal	Color	Signal	Color	Signal	Color
1	S32+	RD ²⁾	AI_R32+	PKBN 1)	Al32+	WHBK 1)				YEGY 2)
2	S31+	BU ²⁾	AI_R31+	GYBN 1)	Al31+	WHGY 1)			Internal	GYGN ²⁾
3	S30+	PK ²⁾	AI_R30+	YEBN 1)	Al30+	WHYE 1)			use 3)	BNBK ²⁾
4	S29+	GY 2)	AI_R29+	BNGN 1)	Al29+	WHGN 1)				WHBK 2)
5	S28+	YE 2)	AI_R28+	RDBU 1)	Al28+	GYPK 1)				
6	S27+	GN ²⁾	AI_R27+	VT 1)	Al27+	BK 1)				
7	S26+	BN ²⁾	AI_R26+	RD ¹⁾	Al26+	BU 1)				
8	S25+	WH ²⁾	AI_R25+	PK 1)	Al25+	GY 1)				
9	S24+	RDBK 1)	AI_R24+	YE 1)	Al24+	GN 1)				
10	S23+	BUBK 1)	AI_R23+	BN 1)	Al23+	WH 1)				
11	S22+	PKBK 1)	AI_R22+	RDBK	Al22+	BUBK				
12	S21+	GYBK 1)	AI_R21+	PKBK	Al21+	GYBK				
13	S20+	PKRD 1)	AI_R20+	PKRD	AI20+	GYRD				
14	S19+	GYRD 1)	AI_R19+	PKBU	AI19+	GYBU				
15	S18+	PKBU 1)	AI_R18+	YEBK	AI18+	GNBK				
16	S17+	GYBU 1)	AI_R17+	YERD	AI17+	GNRD				
17	S16+	YEBK 1)	AI_R16+	YEBU	AI16+	GNBU	S-	BNRD ²⁾		
18	S15+	GNBK 1)	AI_R15+	YEPK	AI15+	PKGN	S-	WHRD ²⁾		
19	S14+	YERD 1)	AI_R14+	YEGY	AI14+	GYGN	S-	BNBU ²⁾		
20	S13+	GNRD 1)	AI_R13+	BNBK	AI13+	WHBK	S-	WHBU 2)		
21	S12+	YEBU 1)	AI_R12+	BNRD	AI12+	WHRD	S-	PKBN ²⁾		
22	S11+	GNBU 1)	AI_R11+	BNBU	Al11+	WHBU	S-	WHPK ²⁾		
23	S10+	YEPK 1)	AI_R10+	PKBN	AI10+	WHPK	S-	GYBN ²⁾		
24	S9+	PKGN 1)	AI_R9+	GYBN	Al9+	WHGY	S-	WHGY ²⁾		
25	S8+	YEGY 1)	AI_R8+	YEBN	Al8+	WHYE	AI-	YEBN ²⁾		
26	S7+	GYGN 1)	AI_R7+	BNGN	AI7+	WHGN	AI-	WHYE 2)		
27	S6+	BNBK 1)	AI_R6+	RDBU	Al6+	GYPK	AI-	BNGN ²⁾		
28	S5+	WHBK 1)	Al_R5+	VT	Al5+	BK	Al-	WHGN ²⁾		
29	S4+	BNRD 1)	Al_R4+	RD	Al4+	BU	Al-	RDBU 2)		
30	S3+	WHRD 1)	AI_R3+	PK	Al3+	GY	Al-	GYPK ²⁾		
31	S2+	BNBU 1)	Al_R2+	YE	Al2+	GN	Al-	YT ²⁾		
32	S1+	WHBU 1)	Al_R1+	BN	Al1+	WH	Al-	BK ²⁾		

¹⁾ For the first repeated wire color coding: Additional orange ring.

Table 16: Pin Assignment for the Cable Plugs of System Cable X-CA 009

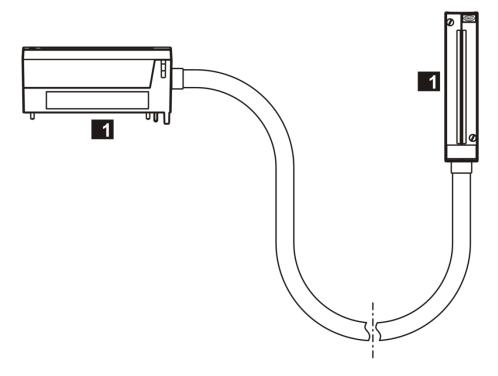
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²⁾ For the second repeated wire color coding: Additional violet ring.

³⁾ The wires must be isolated individually! No other use is permitted!

3.8 System Cables

The system cables connect the connector boards to the field termination assemblies. Depending on the type of connector board, several types of system cables are available. System cable X-CA 016 with a reduced number of wires and open wire ends is available for applications with active transmitters.



1 Identical cable plugs

Figure 9: System Cable with Cable Plug on Both Sides

3.8.1 System Cable X-CA 005

System cable X-CA 005 is used to connect the X-CB 008 03/04 connector board to one field termination assembly.

General	
Cable	LIYCY-TP 38 x 2 x 0.25 mm² (shielded)
Wire	Finely stranded
Average outer diameter (d)	Approx. 16.8 mm
	Max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Color coding	Based on DIN 47100, see Table 13.

Table 17: Cable Data X-CA 005

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The system cable is available in the following standard lengths:

System cables	Description	Length	Weight
X-CA 005 01 8	Coded cable plugs on both	8 m	4.25 kg
X-CA 005 01 15	sides.	15 m	8 kg
X-CA 005 01 30		30 m	16 kg

Table 18: Available Standard System Cables X-CA 005

3.8.2 System Cable X-CA 009

System cable X-CA 009 is used to connect the X-CB 008 05 connector board to the field termination assembly.

General	
Cable	LIYCY-TP 58 x 2 x 0.14 mm² (shielded)
Wire	Finely stranded
Average outer diameter (d) Approx. 18.3 mm	
	Max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Color coding	Based on DIN 47100, see Table 16.

Table 19: Cable Data X-CA 009

The system cable is available in the following standard lengths:

System cables	Description	Length	Weight
X-CA 009 01 8	Coded cable plugs on both	8 m	4.25 kg
X-CA 009 01 15	sides.	15 m	8 kg
X-CA 009 01 30		30 m	16 kg

Table 20: Available Standard System Cables X-CA 009

3.8.3 System Cable X-CA 016

If no transmitter supply is required, system cable X-CA 016 can be used for connection to active transmitters. System cable X-CA 016 is implemented with a reduced number of wires and open wire ends. The open wire ends must be connected to terminals.

The system cable is available as standard type (X-CA 016 02) and as halogen-free, UL/CSA certified type (X-CA 016 04) in the following standard lengths:

System cables	Description	Length	Weight
X-CA 016 02 5	Cable plug coded on one side, with open wire ends.	5 m	2 kg
X-CA 016 02 8		8 m	3.25 kg
X-CA 016 02 15		15 m	6 kg
X-CA 016 02 30		30 m	12 kg
X-CA 016 04 5	Cable plug coded on one side, with open wire ends, halogen-free.	5 m	1.75 kg
X-CA 016 04 8		8 m	2.75 kg
X-CA 016 04 15		15 m	5.25 kg
X-CA 016 04 30		30 m	10.5 kg

Table 21: Available System Cables X-CA 016

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X-CA 016 02	
Cable	LIYCY-TP 32 x 2 x 0.25 mm² (shielded)
Wire	Finely stranded
Average outer diameter (d)	Approx. 17.0 mm, max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Color coding	Based on DIN 47100, see Table 14.

Table 22: Cable Data X-CA 016 02

X-CA 016 04	
Cable	LIYHCH-TP 32 x 2 x 0.25 mm² (shielded)
Wire	Finely stranded
Average outer diameter (d)	Approx. 15.8 mm, max. 20 mm for all types of system cables
Minimum bending radius Fixed installation Flexible application	5 x d 10 x d
Burning behavior	Flame retardant in accordance with IEC 60332-1-2, IEC 60332-2-2 IEC 61034-1/IEC 61034-2 (smoke density) UL c/us 758/1581 CSA FT2 UL c/us 20549/10493
Halogen-free	In accordance with IEC 60754-1
Color coding	Based on DIN 47100, see Table 14.

Table 23: Cable Data X-CA 016 04

3.8.4 Cable Plug Coding

The cable plugs are equipped with three coding pins. Therefore, cable plugs only match connector boards and FTAs encoded accordingly, see Figure 7 und Figure 8.

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4 Start-Up X-AI 32 02

4 Start-Up

This chapter describes how to install, configure and connect the module. For further details, refer to the HIMax system manual (HI 800 001 E).

1 The safety-related application (SIL 3 in accordance with IEC 61508) of the inputs and the connected sensors must comply with the safety requirements. For further details, refer to the HIMax safety manual (HI 801 003 E).

4.1 Mounting

Observe the following points when mounting the module:

- Only operate the module with the appropriate fan components. For further details, see the system manual (HI 801 001 E).
- Only operate the module with the suitable connector board. For further details, see Chapter 3.7.
- The module, including its connected components, must be installed to ensure compliance with the requirements for degree of protection IP20 or higher in accordance with EN 60529:1991 + A1:2000.

NOTICE



Damage due to incorrect wiring!

Failure to comply with these instructions can damage the electronic components. Observe the following points.

- Plugs and terminals connected to the field level.
 - Take the appropriate grounding measures when connecting the plugs and terminals to the field level.
 - Use shielded cables with twisted pairs.
 - Use one twisted pair of shielded cables for each measurement inputs.
 - The shielding must be connected on both sides. On the module side, the shielding must be connected to the cable shield rail (use SK 20 shield connection terminal block or similar).
 - If finely stranded wires are used, HIMA recommends fastening ferrules to the wire ends.
 The terminals must be suitable for fastening the cross-sections of the cables in use.
- If the transmitter supply is used, use the supply assigned to the input, e.g., S1+ with Al1+.
- HIMA recommends using the transmitter supply of the module.
 If an external current source is malfunctioning, the affected module's measurement input can be overloaded and damaged. If an external current source is used, the zero and final values must be checked after a non-transient overload occurred at the measuring inputs.
- The inputs may be wired redundantly using the corresponding connector boards. For further details, see Chapters 3.7 and 4.5.

4.1.1 Wiring Unused Inputs

Inputs that are not being used may stay open and need not be terminated. However, to prevent short-circuits, never connect a wire to a connector board if it is open on the field level.

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X-AI 32 02 4 Start-Up

4.2 Mounting and Removing the Module

This chapter describes how to replace an existing module or mount a new one.

When removing the module, the connector board remains in the HIMax base plate. This saves additional wiring effort at the clamp terminals since all field terminals are connected via the connector board of the module.

4.2.1 Mounting a Connector Board

Tools and utilities:

- Screwdriver, cross PH 1 or slotted 0.8 x 4.0 mm.
- Matching connector board.

To install the connector board

- 1. Insert the connector board into the guiding rail with the groove facing upwards (see following drawing). Fit the groove into the guiding rail pin.
- 2. Place the connector board on the cable shield rail.
- Secure the captive screws to the base plate. First screw in the lower screws than the upper ones.

To remove the connector board

- 1. Release the captive screws from the base plate.
- 2. Carefully lift the lower section of the connector board from the cable shield rail.
- 3. Remove the connector board from the guiding rail.

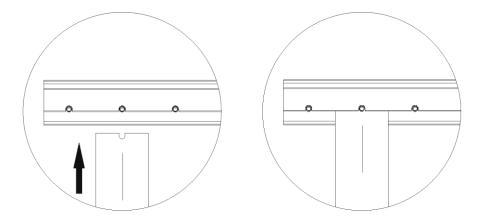


Figure 10: Example of how to Insert the Mono Connector Board

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4 Start-Up X-AI 32 02

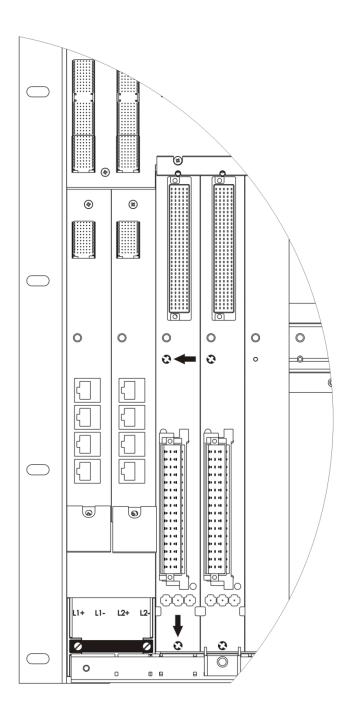


Figure 11: Example of how to Secure the Mono Connector Board with Captive Screws

These instructions also apply for redundant connector boards. The number of used slots varies in accordance with the connector board type. The number of captive screws depends on the connector board type.

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X-AI 32 02 4 Start-Up

4.2.2 Mounting and Removing a Module

This chapter describes how to mount and remove the HIMax module. A module can be mounted and removed while the HIMax system is operating.

NOTICE



Damage to bus and power sockets due to module jamming!
Failure to comply with these instructions can damage the controller.

Always insert the module in the base plate carefully.

Tools and utilities:

- Screwdriver, slotted 0.8 x 4.0 mm.
- Screwdriver, slotted 1.2 x 8.0 mm.

To insert the modules

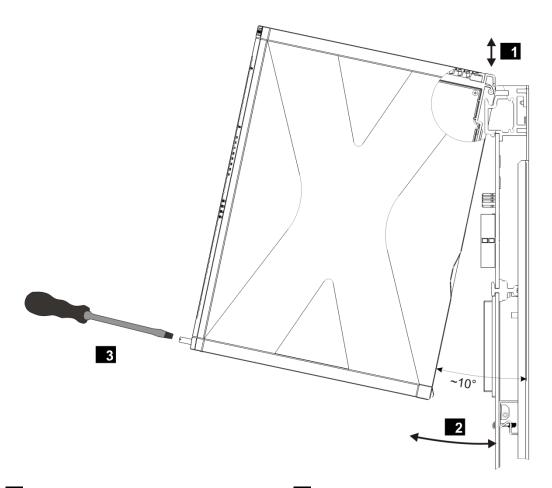
- 1. Open the cover plate on the fan rack:
 - ☑ Move the locks to the *open* position.
 - ☑ Lift the cover plate and insert it into the fan rack.
- 2. Insert the top of the module into the hook-in rail, see 1.
- 3. Swivel the lower edge of the module towards the base plate and apply light pressure to snap it into place, see 2.
- 4. Tighten the screws, see 3.
- 5. Pull the cover plate out of the fan rack and close it.
- 6. Lock the cover plate.

To remove the modules

- 1. Open the cover plate on the fan rack:
 - ☑ Move the locks to the *open* position.
 - ☑ Lift the cover plate and insert it into the fan rack.
- Release the screw, see 3.
- 3. Swivel the lower edge of the module away from the base plate. Lift and apply light pressure to remove the module from the hook-in rail, see 2 and 1.
- 4. Pull the cover plate out of the fan rack and close it.
- 5. Lock the cover plate.

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4 Start-Up X-AI 32 02



- Inserting and removing a module
- 2 Swiveling the module in and out
- 3 Securing and releasing a module

Figure 12: Mounting and Removing a Module

if the HIMax system is operating, do not open the cover plate of the fan rack for more than a few minutes (< 10 min) since this affects the forced cooling.

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4.3 Sequence of Events Recording (SOE)

Exactly one event (I/O event) can be configured for each channel. The configuration is performed using the programming tool SILworX, see the online help and the communication manual (HI 801 101 E).

During each cycle (2 ms), the I/O module reads the values measured for the digital inputs and records the events that are stored in the volatile I/O event buffer.

An event is composed of:

Event	Description
Event ID	The event ID is assigned by the PADT.
Timestamp	Date (e.g., 21/11/2008) Time (e.g., 9:31:57.531)
Event state	Alarm/Normal
Event quality	Quality good/ Quality bad, see www.opcfoundation.org

Table 24: Event Description

The processor module reads the events from the I/O event buffer cyclically and stores them in its non-volatile memory. Events stored in the I/O event buffer can be overwritten with new events read by the processor module.

If the I/O event buffer is full, the I/O module creates an overflow system event entry in the non-volatile memory of the processor module. Thereafter, events are no longer recorded until existing events have been read and space is once again available in the buffer.

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4.4 Configuring the Module in SILworX

The module is configured in the Hardware Editor of the SILworX programming tool.

Observe the following points when configuring the module:

 To diagnose the module and channels, both the statuses and the measured value can be evaluated within the user program. For further details on the system parameters, refer to the following tables.

If the 0 value is within the valid measuring range, the user program must evaluate the -> Channel OK [BOOL] status in addition to the -> Raw Value [BOOL]. This and other diagnostic statuses (such as short-circuits and open-circuits) provide additional options for diagnosing the external wiring and configuring proper fault response in the user program.

- When scaling the input value -> Raw Value [DINT], users must make sure that the scaling
 result is within the range of values for the REAL data type. Representation of the scaling
 result must be possible with a REAL variable.
- For short-circuit and open-circuit monitoring, two thresholds are detected by the module. The switching thresholds can be set in SILworX in the module configuration. By default, the limits are set to the OC/SC values specified in NAMUR, Recommendation NE 43.
- If the transmitter supply of the module is used (i.e., Supply ON parameter), the Sup. Used parameter must also be activated for the corresponding channel. To diagnose the transmitter supply in use, evaluate the Sup. Used parameter in the user program.
 - For further details on these system parameters, refer to Table 26 and Table 27.
- If a redundancy group is created, its configuration is defined in the tabs. The tabs specific to the redundancy group differ from those of the individual modules, see the following tables.

The transmitter supply is monitored.

If a fault occurs in the transmitter supply, the module reports a channel fault and sets the process value to the initial value of the connected global variables.

To evaluate the system parameters in the user program, they must be assigned to global variables. Perform this step in the Hardware Editor using the module's detail view.

The following tables present the system parameters for the module in the same order as in the SILworX Hardware Editor.

TIP A scientific calculator such as the Windows® calculator with the corresponding view can be used to convert hexadecimal values to bit strings.

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4.4.1 The **Module** Tab

The **Module** tab contains the following system parameters for the module:

System parameters Date			R/W	Description		
Noise Blanking BO System parameters Day The following statuses and parameters			W	Module name.		
System parameters Date The following statuses and parameters	OOL	N	8	Activated: It is not considered a fault if a module of the redundancy group is missing in the base plate. Deactivated: It is considered a fault if a module of the redundancy group is missing in the base plate Default setting: Deactivated It is only displayed in the redundancy group tab!		
The following statuses and para	OOL	N	W	Allow noise blanking performed by the process module (activated/deactivated). Default setting: Activated The processor module delays its response to transien interference until the safety time. The user program retains its last valid process value. Refer to the system manual (HI 801 001 E) for further details on noise blanking.		
	ta type	S 1)	R/W	Description		
Module OK BO					ables and used in the user program.	
	OL	Υ	R	TRUE:	No module fault.	
				the individual <i>Module OK</i> p	 It may refer to: Short-circuit or open-circuit. Channel fault on at least one channel. Module fault. The module is not plugged in. Observe the <i>Module Status</i> parameter! acy groups, the <i>Module OK</i> parameter of modules are grouped to a higher-level parameters following the OR logic. 	
Module Status DW	VORD	Y	R		Description Module fault. 2) Temperature threshold 1 exceeded. Temperature threshold 2 exceeded. Incorrect temperature value. Voltage on L1+ is defective. Voltage on L2+ is defective. Internal voltage is defective. No connection to the module. 2) Jults affect the Module OK status and the separately evaluated in the user	
Timestamp [µs] DW	VORD	N	R	Microsecond fraction of the timestamp. Point in time at which the analog inputs were measured.		
Timestamp [s] DW						

Table 25: The **Module** Tab in the Hardware Editor

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4.4.2 Tab **I/O Submodule Al32_02**

The I/O Submodule Al32_02 tab contains the following system parameters:

System parameters	Data type	S 1)	R/W	Description
Name			W	Module name.
Supply ON	BOOL	N	W	Use the transmitter supplies of the module. Activated: Transmitter supplies for channels 132 are activated. Deactivated: Transmitter supplies for channels 132 are deactivated. Default setting: Activated
Show Signal Overflow	BOOL	N	W	The Field LED displays any signal overflow. Activated: The Show Signal Overflow option is activated. Deactivated: The Show Signal Overflow option is deactivated. Default setting: Activated
Show Supply Overcurrent	BOOL	N	W	Show supply overcurrent with Field LED. Activated: The Show Supply Overcurrent option is activated. Deactivated: The Show Supply Overcurrent option is deactivated. Default setting: Activated
System parameters	Data type	S 1)	R/W	Description
The following statuses and	parameters	can be	assigr	ned global variables and used in the user program.
Diagnostic Request	DINT	N	W	To request a diagnostic value, the appropriate ID must be sent to the module using the parameter <i>Diagnostic Request</i> (for coding details, see Chapter 4.4.5).
Diagnostic Response	DINT	N	R	As soon as <i>Diagnostic Response</i> returns the ID of <i>Diagnostic Request</i> (for coding details, see Chapter 4.4.5), <i>Diagnostic Status</i> contains the diagnostic value requested.
Diagnostic Status	DWORD	N	R	Requested diagnostic value in accordance with Diagnostic Response. The IDs of Diagnostic Request and Diagnostic Response can be evaluated in the user program. Diagnostic Status only contains the requested diagnostic value when both Diagnostic Request and Diagnostic Response have the same ID.
Background Test Error	BOOL	N	R	TRUE: Background test is faulty. FALSE: Background test is not faulty.
Restart on Error	BOOL	Υ	W	The Restart on Error parameter can be used to cause any I/O module that is shut down permanently due to errors or faults to once again enter the RUN state. To do so, set the Restart on Error parameter from FALSE to TRUE. The I/O module performs a complete self-test and only enters the RUN state if no faults are detected. Default setting: FALSE

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System parameters	Data type	S 1)	R/W	Description	
Submodule OK	BOOL	Y	R	TRUE:	It may refer to: No submodule fault. No channel fault.
				No channel fault. FALSE: It may refer to: Short-circuit or open-circuit. Channel fault on at least one channel. Submodule fault. Observe the Submodule Status parameter! For redundancy groups, the Submodule OK parameters of the individual modules are grouped to higher-level Submodule OK parameter following the	
	DWODD		_	OR logic.	
Submodule Status	DWORD	N	R		omodule status. etails, see Chapter 4.4.4.
1) The operating system	handles the sy	/stem	parame	eter in a safety-	-related manner, yes (Y) or no (N).

Table 26: The I/O Submodule Al32_02 Tab in the Hardware Editor

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4.4.3 The **I/O Submodule Al32_02: Channels** Tab

The **I/O Submodule Al32_02: Channels** tab contains the following system parameters for each analog input.

Global variables can be assigned to the system parameters with -> and used in the user program. The value without -> must be directly entered.

System parameters	Data type	S 1)	R/W	Description
Channel no.			R	Channel number, preset and cannot be changed.
-> Process Value [REAL]	REAL	Υ	R	Process value determined using the data points 4 mA and 20 mA.
4 mA	REAL	Υ	W	Data point used to calculate the process value at the lowest full scale (4 mA) of the channel. Default setting: 4.0
20 mA	REAL	Y	W	Data point used to calculate the process value at the upper full scale (20 mA) of the channel. Default setting: 20.0
-> Raw Value [DINT]	DINT	N	R	Unprocessed measured value of the channel: 0200 000 (020 mA). If the raw value is evaluated instead of the process value, the user must program the monitoring function and the value in the event of faults from within the user program.
-> Channel OK [BOOL]	BOOL	Y	R	TRUE: Fault-free channel. The input value is valid. FALSE: Faulty channel. The input value is set to 0.
Sup. Used	BOOL	Y	W	Activated: If a fault occurs in the transmitter supply, the module reports a channel fault and sets the input value to 0. Deactivated: If a fault occurs in the transmitter supply, the module reports no channel fault and the input value is undefined. Default setting: Activated
-> Supply OK [BOOL]	BOOL	Y	R	TRUE: The transmitter supply is not faulty. FALSE: The transmitter supply is faulty.
OC Limit	DINT	Υ	W	Threshold in mA for detecting an open-circuit. If the analog measured value falls under <i>OC Limit</i> , the module detects an open-circuit and switches off the <i>Channel</i> LED for this channel. Default setting: 36 000 (3.6 mA)
-> OC [BOOL]	BOOL	Υ	R	TRUE: Open-circuit present. FALSE: No open-circuit present. Defined through <i>OC Limit</i> .
SC Limit	DINT	Υ	W	Threshold in mA for detecting a short-circuit. If the measured analog value exceeds <i>SC Limit</i> , the module detects a short-circuit and sets the <i>Channel LED</i> for this channel to <i>Blinking2</i> . Default setting: 213 000 (21.3 mA)
-> SC [BOOL]	BOOL	Υ	R	TRUE: Short-circuit present. FALSE: No short-circuit present. Defined through <i>SC Limit</i> .

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System parameters	Data type	S 1)	R/W	Description
SP LOW	DINT	Y	W	Low level upper limit. SP LOW (switching point LOW) is the limit value: if this limit is exceeded, the module detects LOW and switches off the Channel LED. Restriction: SP LOW ≤ SP HIGH Default setting: 39 500 (3.95 mA)
SP HIGH	DINT	Y	W	High level lower limit SP HIGH (switching point HIGH) is the limit value: if this limit is exceeded, the module detects a HIGH and switches on the Channel LED. Restriction: SP LOW ≤ SP HIGH Default setting: 40 500 (4.05 mA)
-> Channel Value [BOOL]	BOOL	Y	R	Boolean channel value in accordance with the limits. SP LOW and SP HIGH
T on [μs]	UDINT	Y	W	Time on delay The module only indicates a level change from LOW to HIGH if the high level is present for longer than the configured time t _{on} . Important: The maximum response time T _R (worst case) for this channel is extended by the configured delay, since a signal change is not detected until the configured delay has expired. For blanking surge pulses in accordance with EN 61000-4-5, a time-on delay of 2000 μs must be configured. Range of values: 0(2 ³² - 1) Granularity: 1000 μs, e.g., 0, 1000, 2000, Default setting: 0
T off [μs]	UDINT	Y	W	Time off delay The module only indicates a level change from HIGH to LOW if the low level is present for longer than the configured time toff. Important: The maximum response time T _R (worst case) for this channel is extended by the configured delay, since a signal change is not detected until the configured delay has expired. For blanking surge pulses in accordance with EN 61000-4-5, a time off delay of 2000 μs must be configured. Range of values: 0(2 ³² - 1) Granularity: 1000 μs, e.g., 0, 1000, 2000, Default setting: 0
-> State LL [BOOL]	BOOL	Υ	R	TRUE: Value within the LL event state. FALSE: Value outside the LL event state.
-> State L [BOOL]	BOOL	Y	R	TRUE: Value within the L event state. FALSE: Value outside the L event state.
-> State N [BOOL]	BOOL	Y	R	TRUE: Value within the N (normal) event state. FALSE: Value outside the N (normal) event state.
-> State H [BOOL]	BOOL	Y	R	TRUE: Value within the H event state. FALSE: Value outside the H event state.
-> State HH [BOOL]	BOOL	Y	R	TRUE: Value within the HH event state. FALSE: Value outside the HH event state.

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System parameters	Data type	S 1)	R/W	Description
Redund.	BOOL	Υ	W	Requirement: The redundant module must exist.
				Activated: The channel redundancy for this channel is active.
				Deactivated: The channel redundancy for this channel
				is not active.
				Default setting: Deactivated
Redundancy Value	BYTE	Υ	W	Settings for determining the redundancy value:
				■ Min
				■ Max
				Average
				Default setting: Max
				If a module error occurs, the default setting applies.
				It is only displayed in the redundancy group tab!
1) The operating system	handles the sy	/stem	parame	eter in a safety-related manner, yes (Y) or no (N).

Table 27: The I/O Submodule Al32_02: Channels Tab in the Hardware Editor

4.4.4 Description of **Submodule Status [DWORD]**

The following table specifies the coding of the *Submodule Status* parameter:

Coding	Description
0x00000001	Fault in hardware unit (submodule).
0x00000002	Reset of an I/O bus.
0x00000004	Fault detected while initializing the hardware.
0x00000008	Fault detected while checking the coefficients.
0x10000000	Fault during AD conversion (conversion end).
0x20000000	Operating voltages faulty.
0x40000000	Fault during A/D conversion (conversion begin).
0x80000000	Test function of transmitter monitoring overvoltage.

Table 28: Coding of Submodule Status [DWORD]

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4.4.5 Description of **Diagnostic Status [DWORD]**

The following table specifies the coding of the *Diagnostic Status* parameter:

ID	Description						
0	Diagnostic values are indicated consecutively.						
100	Bit-coded temperature status						
	0 = normal						
		perature threshold 1 has been exceeded.					
		perature threshold 2 has been exceeded.					
		ult in temperature measurement.					
101		mperature (10 000 digits/ °C).					
200	Bit-coded vol 0 = normal	tage status					
		- (24 V) is faulty.					
		- (24 V) is faulty. - (24 V) is faulty.					
201	Not used!	- (24 V) is laulty.					
202		of the internal core voltage.					
203		of the internal core voltage.					
204207	Not used!	of the internal core voltage.					
300		24 V undervoltage (BOOL)					
10011032		channels 132					
10011002	Coding	Description					
	0x0001	Fault occurred in hardware unit (submodule).					
	0x0001	Channel fault due to internal fault.					
	0x0400	SC / OC limits violated or					
	00400	channel/module fault.					
	0x0800	Measured values invalid (potential measurement system fault).					
	0x1000	Measured value not compliant with the specified accuracy.					
	0x2000	Underflow or overflow of the measured value.					
	0x4000	Channel not configured.					
	0x8000	Independent measurements of both measurement systems					
		malfunctioning.					
20012032	Fault status of the power sources 132						
	Coding Description						
	0x0001	Module fault					
	0x1000	Undervoltage of transmitter monitoring.					
	0x2000	Max. number of transmitter supplies that are simultaneously					
		short-circuited.					
	0x4000	Undervoltage of transmitter supply.					
	0x8000	Overvoltage of transmitter supply.					

Table 29: Coding of Diagnostic Status [DWORD]

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4.5 Connection Variants

This chapter describes the proper wiring of the module in safety-related applications. The following connection variants are permitted.

4.5.1 Input Wiring Variants

The inputs are wired via connector boards. Special connector boards are available for redundantly wiring the modules.

The transmitter supplies are decoupled using diodes. This ensures that the transmitter supplies of two modules can supply one transmitter if the modules are redundant to one another.

Connector boards X-CB 008 01 (with screw terminals) or X-CB 008 03 (with cable plug) can be used to perform the wiring such as described in Figure 13 and Figure 14.

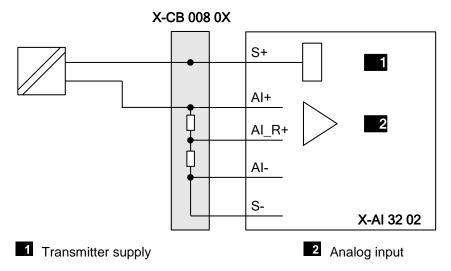


Figure 13: Single-Channel Connection to Passive 2-Wire Transmitter

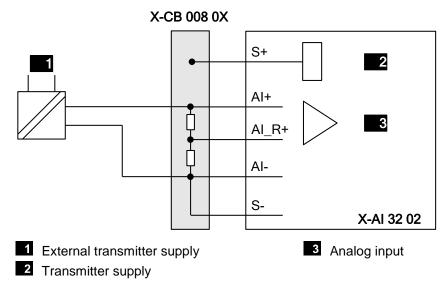


Figure 14: Single-Channel Connection to Active 2-Wire Transmitter

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When redundantly wired as specified in Figure 15 and Figure 16, the modules are inserted in the base plate next to each other and on a common connector board. Connector boards X-CB 008 02 (with screw terminals) or X-CB 008 04 (with cable plug) can be used.

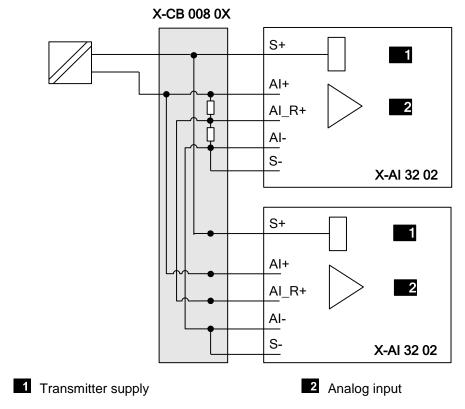


Figure 15: Redundant Connection to Passive 2-Wire Transmitter

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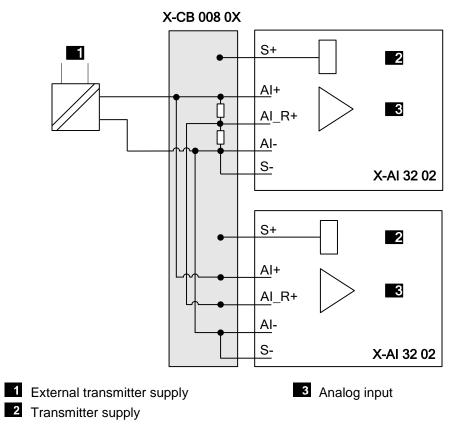


Figure 16: Redundant Connection to Active 2-Wire Transmitter

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4.5.2 Wiring Transmitters via Field Termination Assembly

The connection to passive and active 2-wire transmitters via the X-FTA 002 01 is performed as described in Figure 17. For further information, refer to the X-FTA 002 01 manual (HI 801 117 E).

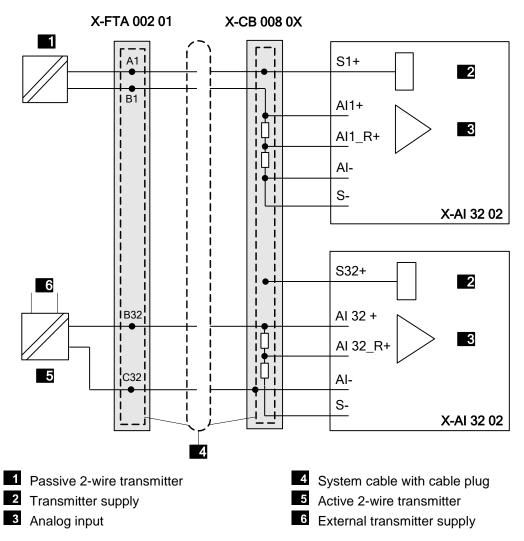


Figure 17: Connection via Field Termination Assembly

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4.5.3 Redundant Connection via Two Base Plates

The figure shows the connection of one transmitter if the redundant modules are inserted in different base plates or not located adjacently in the rack. The shunts are placed on the field termination assembly.

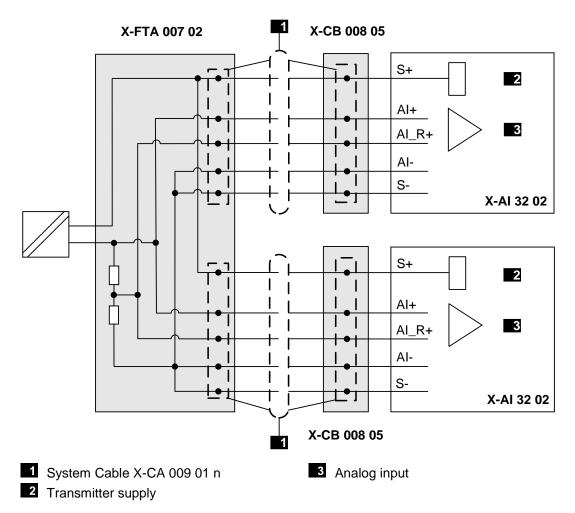


Figure 18: Redundant Connection via Two Base Plates

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4.5.4 Ex Protection with Zener Barriers

Zener barriers can be used for Ex protection, e.g., barriers from MTL, type 7787+ or Pepperl+Fuchs, type Z787.

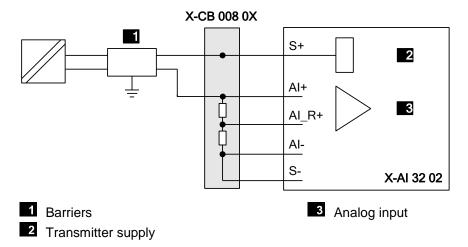


Figure 19: Single-Channel Transmitter Connection with Barrier

4.5.5 Ex Protection with Repeater Power Supply

Repeater power supply can be used for Ex protection, e.g., the analog repeater power supply H 6200A from HIMA. The transmitter supply is not used when analog repeater power supply isolator is wired.

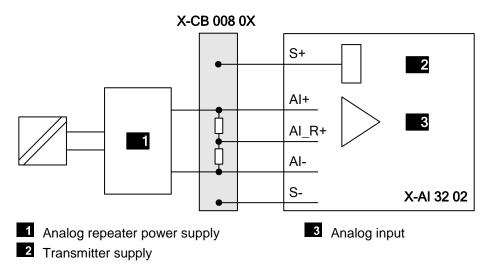


Figure 20: Single-Channel Wiring of Analog Repeater Power Supply

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4.5.6 Behavior during HART Communication

To ensure HART communication, a HART handheld can be connected in parallel to the transmitter. Filters in the analog input are used to filter out the current fluctuations caused by the HART communication, so that the residual error of the analog measurement is 1 %.

Increased residual error in HART communication. Remove the HART terminal immediately after diagnosis!

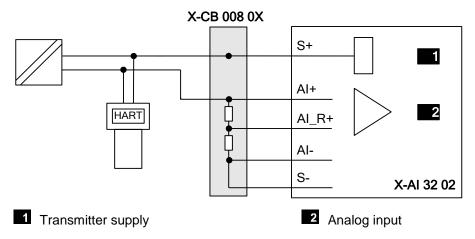


Figure 21: HART Handheld in Parallel to the Transmitter and Input Module

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X-AI 32 02 5 Operation

5 Operation

The module runs within a HIMax base plate and does not require any specific monitoring.

5.1 Handling

Direct handling of the module is not foreseen.

The module is operated from within the PADT, e.g., for forcing the analog inputs. For further details, refer to the SILworX documentation.

5.2 Diagnostics

LEDs on the front side of the module indicate the module state, see Chapter 3.5.2.

The diagnostic history of the module can also be read using SILworX. Chapter 4.4.4 and Chapter 4.4.5 describe the most important diagnostic statuses.

If a module is plugged in to a base plate, it generates diagnostic messages during its initialization phase indicating faults such as incorrect voltage values.

These messages only indicate a module fault if they occur after the system starts operation.

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6 Maintenance X-AI 32 02

6 Maintenance

Defective modules must be replaced with modules of the same type or with approved replacement models.

When replacing modules, observe the instructions specified in the HIMax system manual (HI 801 001 E) and HIMax safety manual (HI 801 003 E).

6.1 Maintenance Measures

The following maintenance measures must be implemented for the modules:

- Proof testing.
- Loading of enhanced operating system versions.

6.1.1 Proof Test

The proof test interval for HIMax modules must be in accordance with the interval required by the application-specific safety integrity level (SIL). For further details, refer to the safety manual (HI 801 003 E).

6.1.2 Loading of Enhanced Operating System Versions

As part of product maintenance, HIMA is continuously improving the operating systems of the modules. HIMA recommends using system downtimes to load the current operating system versions into the modules.

The current operating system versions of modules are displayed in the SILworX Control Panel. The type label specifies the delivered module version, see Chapter 3.4.

Before loading operating systems into the modules, check the system compatibilities and restrictions of the operating system versions. To this end, use the applicable release notes. Use SILworX to load the operating systems into the modules and ensure that these are in the STOP state.

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X-AI 32 02 7 Decommissioning

7 Decommissioning

To decommission the module, remove it from the base plate. For more details, refer to Chapter *Mounting and Removing the Module*.

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8 Transport X-Al 32 02

8 Transport

To avoid mechanical damage, the components must be transported in packaging.

Always store the components in their original product packaging. This packaging also provides protection against electrostatic discharge (ESD). Note that the product packaging alone is not sufficient for transport.

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X-Al 32 02 9 Disposal

9 Disposal

Industrial customers are responsible for correctly disposing of decommissioned hardware. Upon request, a disposal agreement can be arranged with HIMA.

All materials must be disposed of in an ecologically sound manner.





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9 Disposal X-Al 32 02

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X-AI 32 02 Appendix

Appendix

Glossary

Term	Description
Al	Analog input
AO	Analog output
ARP	Address resolution protocol, network protocol for assigning the network addresses to
	hardware addresses
COM	Communication module
CRC	Cyclic redundancy check
DI	Digital input
DO	Digital output
EMC	Electromagnetic compatibility
EN	European standard
ESD	Electrostatic discharge
FB	Fieldbus
FBD	Function block diagrams
HW	Hardware
ICMP	Internet control message protocol, network protocol for status or error messages
IEC	International electrotechnical commission
Interference-free	Inputs are designed for interference-free operation and can be used in circuits with safety functions
MAC	Media access control address, hardware address of one network connection
PADT	Programming and debugging tool (in accordance with IEC 61131-3), PC with SILworX
PELV	Protective extra low voltage
PES	Programmable electronic system
R	Read, the variable is read out
R/W	Read/Write, column title for system variable type
Rack ID	Base plate identification (number)
r P	Peak value of a total AC component
SB	System bus (module)
SC/OC	Short-circuit/open-circuit
SELV	Safety extra low voltage
SFF	Safe failure fraction, portion of faults that can be safely controlled
SIL	Safety integrity level (in accordance with IEC 61508)
SILworX	Programming tool
SNTP	Simple network time protocol (RFC 1769)
SRS	System.Rack.Slot, addressing of a module
SW	Software
TMO	Timeout
W	Write, the variable receives a value, e.g., from the user program
WD	Watchdog, device for monitoring the system's correct operation Signal for fault-free process
WDT	Watchdog time

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MANUAL **X-Al 32 02**

HI 801 055 E

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